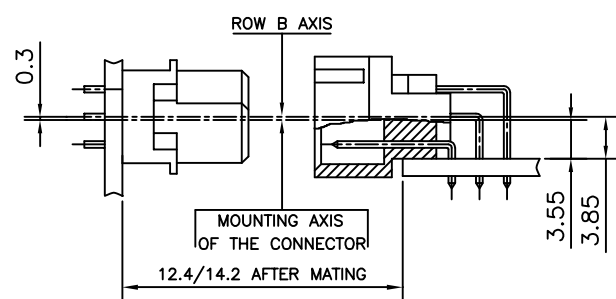


24	2.5
14	4.0
TERM. STYLE	L ^{+0.7} ₋₀



TECHNICAL SPECIFICATION

HOUSING MATERIAL : THERMOPLASTIC POLYESTER UL94V-0, GREY
 HOUSING CAN WITHSTAND EXPOSURE TO LEAD FREE WAVE SOLDERING TEMPERATURE OF 260-265°C FOR STRAIGHT CONNECTORS AS IT IS IN CLASSICAL LEAD WAVE SOLDERING AT 235-250°C

CONTACT / HARPOON MATERIAL : COPPER ALLOY

CONTACT PLATING : GOLD OVER NICKEL

ACTIVE ZONE : GOLD OVER NICKEL

TERMINATION ZONE : TIN LEAD OVER NICKEL

TIN LEAD VERSION : TIN LEAD OVER NICKEL

LEAD FREE VERSION : TIN (PURE MATTE) OVER NI

HARPOON PLATING : TIN LEAD OVER NICKEL

TIN LEAD VERSION : TIN LEAD OVER NICKEL

LEAD FREE VERSION : TIN (PURE MATTE) OVER NI

ELECTRICAL DATA

CURRENT RATING AT 20°C : 1.5 A

CURRENT (I MAX) : 2 A

TEMPERATURE RANGE : -55°C/+125°C

CONTACT RESISTANCE : ≤ 20mΩ

INSULATION RESISTANCE : ≥ 10⁶ MΩ

TEST VOLTAGE (rms) : 1000V

MECHANICAL DATA

INSERTION FORCE PER CONTACT : ≤ 0.94N

EXTRACTION FORCE PER CONTACT : ≥ 0.15N

REFERENCE SPECIFICATIONS : DIN 41612 / IEC 603-2

SERIES	8609	3	48	8	3	14	7	5	5	000E1
ROWS FITTED WITH CONTACTS										
Rows a b c		3	48							
Rows a - c		4	32							
NUMBER OF CONTACTS										
TYPE OF INSULATOR										
3 ROW FEMALE INSULATOR										8
METHOD OF MOUNTING										
STANDARD MOUNTING - STYLE C/2										3
TERMINATION										
LONG STRAIGHT SPILL (L - SEE TABLE)										14
SHORT STRAIGHT SPILL (L - SEE TABLE)										24
OPTIONS										
NO OPTION										7
WITH HARPOONS										H
PERFORMANCE CLASS										
DIN 41612 CLASS 3										4
DIN 41612 CLASS 2										5
DIN 41612 CLASS 1										6
AS PER MIL C 55302/ JSS 50808										8
PITCH PER ROW										
2.54										5
000E1										TIN LEAD VERSION
E1LF										LEAD FREE VERSION

mat'l. code		surface		tolerance		projection		product family	
-		ISO 1302		ISO 406 ISO 1101				8609	
litr		ecn no		dr		date		title	
A		I04-0100		MINI		09/11/2004		DIN STANDARD RECEPTACLE	
B		I05-0042		MINI		19/05/2005		STRAIGHT SPILL DIN 41612 STYLE-C/2	
C		I06-0062		MINI		01/06/2006			
sheet index		revision		dr		date		dwg no	
		C		MINI K VANDANATH		22/09/2004		sheet 1 of 1	
				engr		22/09/2004		size	
				chr		01/06/2006		A3	
				appd		01/06/2006		type	
				RAKHEE GEORGE				Product Customer Drawing	

NOTES:-

- THE "LF" PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 3.5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6 MM MINIMUM THICK CIRCUIT BOARD
- LEAD FREE OR RoHS DIRECTIVE LABELING TO BE PROVIDED AS PER GS-14-920 FOR LEAD FREE VERSION.



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